



- NOTES:
- MATERIAL : NA-311B/BLACK/Al₂O₃ (90%MIN.)
 - CAMBER : ±20.00 MICRON MAX. T.B.D.
 - PLATING THICKNESS:
 ELCTRO Ni : 1.27 ~ 8.89 MICRON.
 ELCTRO Au : 0.70 ~ 1.20 MICRON.
 - CONNECTION:
 (#3-a), (#1-b-c), (#2-#4-S/R)
 - * MARK TO BE MATERIAL DIMENSION.
 - THICKNESS OF BUMP AREA SHALL BE 30.00 ~ 60.00 MICRON INCLUDE MP-11,12.
 - PART TO BE SHOWN AS SIDE METALLIZED PATTERN.
 - SEALING METHOD OF THIS PRODUCT SHALL BE SBAM WBLD.

TOLERANCE * ±1% ** ±1% *** N.L.T.±0.13 ANGLES	REVISION	SEE ATTACHED EXCEPTIONS SHEET.				TITLE	3.2X2.5 XTAL
	SCALE	DIMENSION	PROJECTION	CUSTOMER DWG NO.	REV.	PART NO.	
MATERIAL	APPROVED	CHECKED	ENGRG	CHECKED	DESIGNED	S2532XTAL1	REV. 0
90%MIN.A1203 (NA-311B BLACK)	May.31.02	May.31.02	May.31.02	May.31.02	May.31.02	DWG NO.	SHT/OF 1/5